



• HCX-5FA Series 5.0X3.2X1.40 mm



FEATURES

- Prepared frequencies can meet most of bluetooth chipsets
- Excellent electric performance optimum for mobilephone and bluetooth applications are exhibited
- Excellent heat resistance and shock resistance.
- Products that are lead-free. These can meet the requirement of re-flow profiling using lead-free solder

Electrical Specifications

Item	Туре	HCX-5FB				
Frequency Range	F0	8 to 9.999MHz	10 to19.999MHz	20 to 29.999MHz	30 to 47.999MHz	48 to 80.000MHz
Mode of Vibration		Fundamental 3 rd			3 rd Overtone	
Load Capacitance	CL	10pF to Series				
Frenqency Tolerance	$\triangle F/F0$	± 15 ppm, ± 30 ppm, ± 50 ppm(At 25 °C)				
Equivalent Series Resistance	ESR	100Ω max.	80Ω max.	70Ω max.	50Ω max.	70Ω max.
Temperature Stability	TC	\pm 30ppm, \pm 50ppm(Refer to 25 °C)				
Operating Temperature Range	Topr	- 20~+70°C , - 30~+85°C Option				
Storage Temperature Range	Tstg	- 55~+125°C				
Shunt Capacitance	C0	7pF max.				
Insulator Resistance	IR	500M Ω min. (At 100VDC)				
Drive Level	DL	100µW (300µW max.)				
Aging	Fa	±5ppm max. (At 25°C ,First year)				
Packing Unit		1000pcs/reel				

**Please contact us for inquiries regarding other Specifications

Mechanical Dimensions(mm)



1.40 MAX





Recommended Solder Pattern



12 motion

* Above specification subject to change without prior notice, please consult our sales representative for more information SHENZHEN YJJIN ELECTRONICS CO;LTD TEL:0755-27876565 QQ:857950243 http://www.yijindz.com